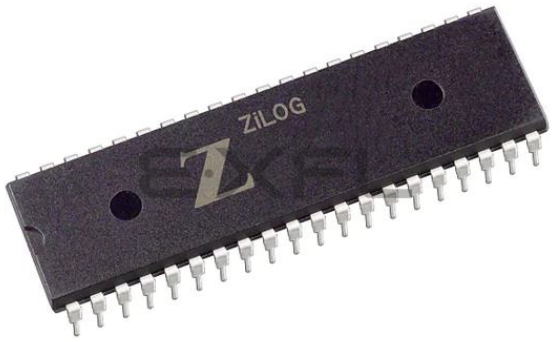

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	16MHz
Connectivity	UART/USART
Peripherals	-
Number of I/O	24
Program Memory Size	-
Program Memory Type	ROMless
EEPROM Size	-
RAM Size	236 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Through Hole
Package / Case	40-DIP (0.620", 15.75mm)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z86c9116peg

Architectural Overview

ZiLOG's large Z8® family of 8-bit ROMless microcontrollers includes the Z86C91 product with 236 bytes of RAM. Each of these devices offer fast execution, efficient use of memory, sophisticated interrupts, input/output bit manipulation capabilities, and easy hardware/software system expansion along with low cost and low power consumption.

For applications demanding powerful I/O capabilities, the Z86C91 offers 24 pins dedicated to input and output. These lines are grouped into four ports. Each port consists of eight lines and is configurable under software control to proviide timing, status signals, serial or parallel I/O with or without handshake and an address/data bus for interfacing external memory. The Z86C91 MCU features three basic address spaces to support this wide range of configurations: Program Memory, Data Memory, and 236 General Purposes Registers.

The Z86C91 operates at 16 MHz with a voltage range of 4.5 to 5.5 VDC.

To unburden the system from coping with real-time tasks such as counting/timing and data communication, the Z86C91 offers two on-chip counter/timers with a large number of user-selectable modes and a full-duplex hardware UART.

The Z86C91 is a ROMless part and offers the use of external memory, which enables this Z8® MCU to be used in high-volume applications, or where code flexibility is required.

Note: All signals with an overline are active Low. For example, B/$\overline{W}$, for which WORD is active Low, and $\overline{B}$/W, for which BYTE is active Low.

Power connections follow these conventional descriptions:

Connection	Circuit	Device
Power	V_{CC}	V_{DD}
Ground	GND	V_{SS}

Z86C91 Features

- Asynchronous receiver/transmitter UART
- 40-Pin DIP and 44-Pin PLCC and QFP Packages
- 4.5- to 5.5-Volt Operating Range
- Operating Temperature Ranges:
  - Standard: 0ºC to 70ºC
  - Extended: -40ºC to 105ºC
- 24 Input/Output Lines

- Six Vectored, Prioritized Interrupts from Eight Different Sources
- Two Programmable 8-Bit Counter/Timers, each with two 6-Bit Programmable Prescalers
- On-Chip Oscillator that accepts a Crystal, Ceramic Resonator, LC, or External Clock
- Two Standby Modes: STOP and HALT
- Auto Latches

Port 3 (P37–P30). Port 3 is an 8-bit, TTL-compatible port, with four fixed inputs (P33–P30) and four fixed outputs (P34–P37). Port 3 is configured under software control for Input/Output, Counter/Timers, interrupt, UART, port handshake, and data Memory functions. Port 3, when used as serial I/O are programmed as serial in and serial out respectively (Figure 8).

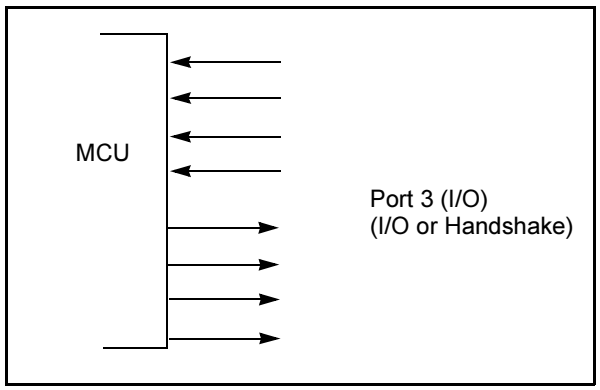


Figure 8. Port 3 Configuration

For interrupt functions, Port 3 inputs are falling-edge interrupt inputs. Access to Counter/Timer 1 is made through P31 (T_{IN}) and P36 (T_{OUT}). Handshake lines for Ports 0, 1, and 2 are available on P31 through P36.

Port 3 also provides the following control functions: handshake for Ports 0, 1, and 2 ($\overline{DAV}$ and RDY); four external interrupt request signals (IRQ3–IRQ0); timer input and output signals (T_{IN} and T_{OUT}); Data Memory Select.

P34 output is software-programmed to function as a Data Memory Select ($\overline{DM}$). The Port 3 Mode Register (P3M) bit D3,D4 selects this function. When accessing external data memory, P34 goes active Low; when accessing external program memory, P34 goes High.

An onboard UART is enabled by software setting bit D5 of the Port 3 Mode Register P3M. When enabled, P30 is the receive input and P37 is the transmit output.

Port 3, lines P30 and P37 are programmed as serial I/O for full-duplex serial asynchronous receiver/transmitter operation. The bit rate is controlled by Counter/Timer0.

The Z8 automatically adds a start bit and two stop bits to transmitted data. Serial Data formats are shown in Figure 9 and Figure 10. Odd parity is also available by setting bit D7 in the P3M register. Eight data bits are always transmitted, regardless of parity selection. If parity is enabled, the eighth bit is the odd parity bit. An interrupt request (IRQ4) is generated on all transmitted characters.

Received data must have a start bit, eight data bits and at least one stop bit. If parity is on, bit 7 of the received data is replaced by a parity error flag. Received characters generate the IRQ3 interrupt request.

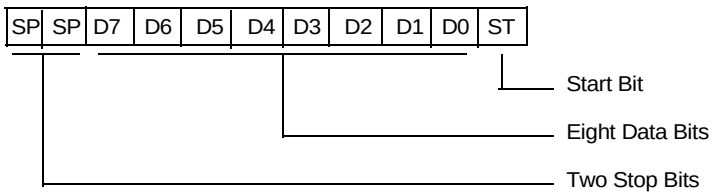


Figure 9. Transmitted Data (No Parity)

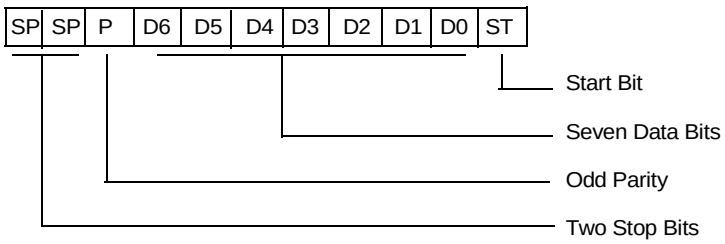


Figure 10. Transmitted Data (With Parity)

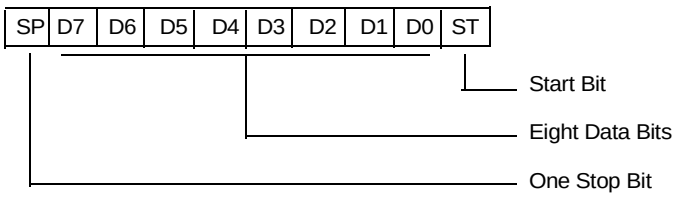


Figure 11. Received Data (No Parity)

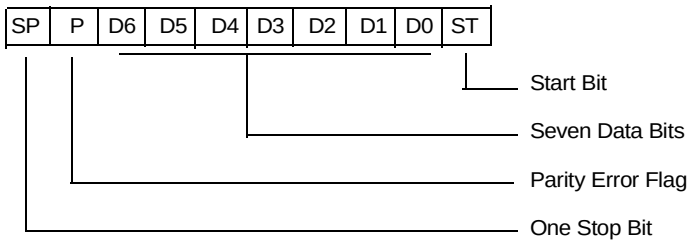


Figure 12. Received Data (With Parity)

Functional Description

The Z8 MCU incorporates the following functions that enhance the standard Z8® architecture and provide the user with increased design flexibility:

- Reset
- Program Memory
- Data Memory
- Working Register
- General-Purpose Registers
- Stack Pointer
- Counter/Timers
- Interrupts
- Clock
- HALT and STOP Modes
- Port Configuration Register

RESET. The device is reset in the following condition:

- External Reset

Automatic Power-On Reset circuitry is not built into this Z8. This Z8 requires an external reset circuit to reset upon power-up. The internal pull-up resistor is on the $\overline{\text{RESET}}$ pin, so a pull-up resistor is not required; however, in a high-EMI (noisy) environment, it is recommended that a low-value pull-up resistor be used.

Program Memory. The Z86C91 can address up to 64 KB of external program memory. The first 12 bytes of program memory are reserved for the interrupt vectors. These locations contain six 16-bit vectors that correspond to the six available interrupts. Program execution begins at external location `000Ch` after reset. See Figure 13.

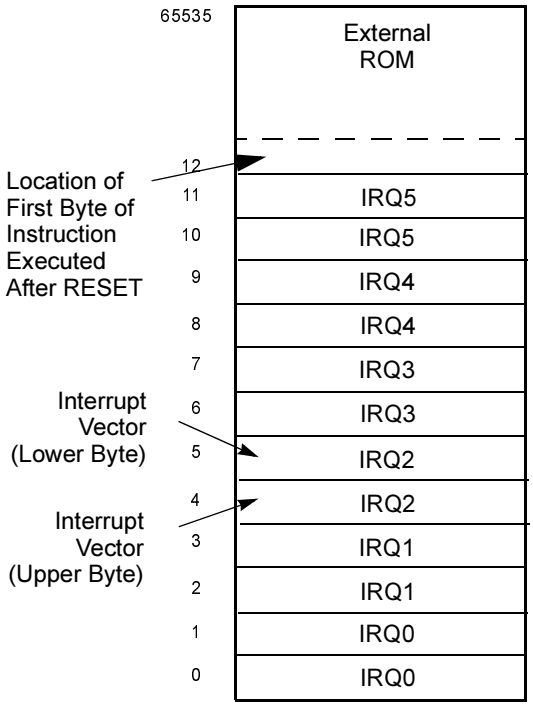


Figure 13. Program Memory Map

Data Memory ($\overline{DM}$). The Z86C91addresses up to 64 KB of external data memory. External data memory may be included with, or separated from, the external program memory space. $\overline{DM}$, an optional I/O function that is programmed to appear on pin P34, is used to distinguish between data and program memory space (Figure 14). The state of the $\overline{DM}$ signal is controlled by the type of instruction being executed. An LDC Op Code references PROGRAM ($\overline{DM}$ inactive) memory, and an LDE instruction references data ($\overline{DM}$ active Low) memory. The user must configure Port 3 Mode Register (P3M) bits D3 and D4 for this mode.

General-Purpose Registers (GPR). General-purpose registers are undefined after the device is powered up. These registers keep the most recent value after any RESET, as long as the RESET occurs in the V_{CC} voltage-specified operating range. General-purpose registers are not guaranteed to keep their most recent state from if V_{CC} drops below the minimum V_{CC} operating range.

Stack Pointer. The Z86C91 has a 16-bit Stack Pointer (SPH and SPL) used for the external stack, that resides anywhere in the data memory. An 8-bit Stack Pointer (SPL) is used for the internal stack that resides within the 236 general-purpose registers. Stack Pointer High (SPH) is used as a general-purpose register only when using an internal stack.

Counter/Timers. There are two 8-bit programmable counter/timers (T0 and T1), each driven by its own 6-bit programmable prescaler. The T1 prescaler is driven by internal or external clock sources; however, the T0 prescaler is driven by the internal clock only (Figure 17).

The 6-bit prescalers can divide the input frequency of the clock source by any integer number from 1to 64. Each prescaler drives its counter, which decrements the value (1 to 256) that is loaded into the counter. When both the counter and prescaler reach the end of the count, a timer interrupt request, IRQ4 (T0) or IRQ5 (T1), is generated.

The counters are programmed to START, STOP, restart to CONTINUE, or restart from the initial value. The counters can also be programmed to STOP upon reaching 1 (SINGLE-PASS mode) or to automatically reload the initial value and continue counting (MODULO–N CONTINUOUS mode).

The counters, but not the prescalers, are read at any time without disturbing their value or count mode. Reading the prescalers returns the value `FFh`. The clock source for T1 is user-definable and is either the internal micro controller clock divide-by-four, or an external signal input through Port 3. The maximum frequency of the external timer signal is the XTAL clock signal divided by 8. The Timer Mode Register configures the external timer input (P31) as an external clock, a trigger input that is retriggerable or nonretriggerable, or as a gate input for the internal clock. Port 3 line P36 also serves as an output (T_{OUT}) through which T0, T1, or the internal clock is output. The counter/timers are cascaded by connecting the T0 output to the input of T1.

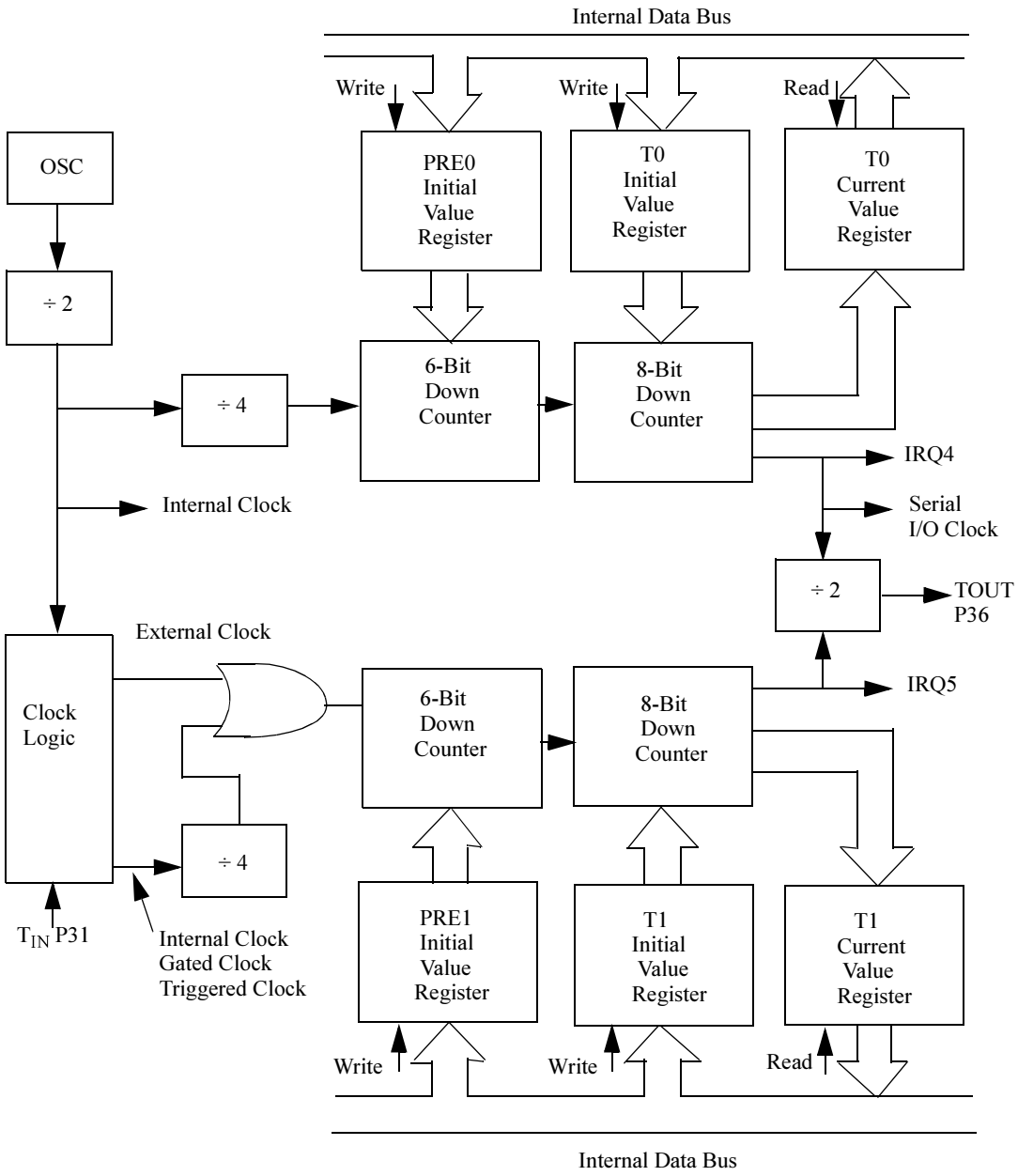


Figure 18. Counter/Timer Block Diagram

Timer Mode Register

The Timer Mode Register, TMR, controls timing and counter functions and shown.in Figure 22.

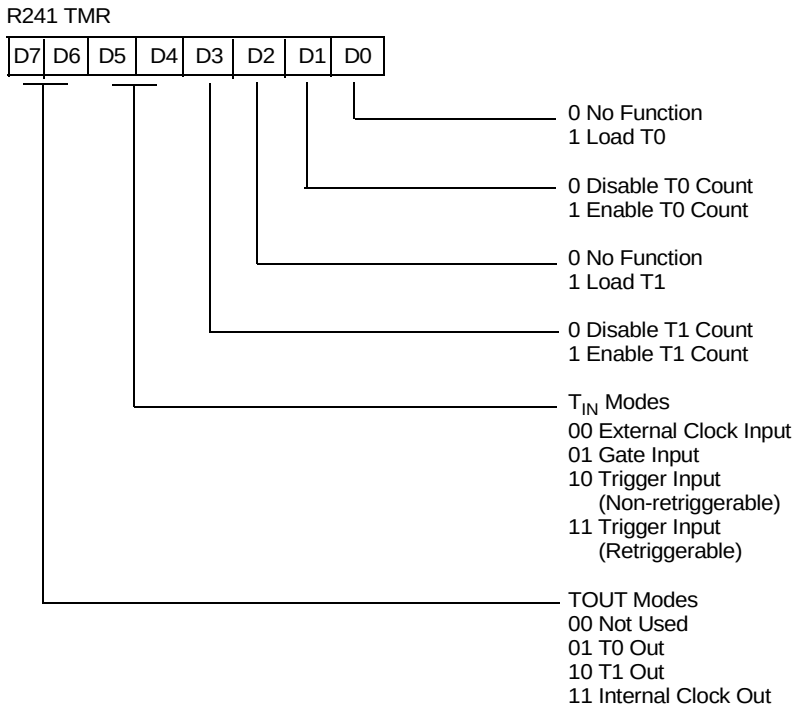


Figure 22. Timer Mode Register (F1h: Read/Write)

Counter/Timer 1 Register

The Counter/Timer 1 Register, T1 is shown in Figure 23.

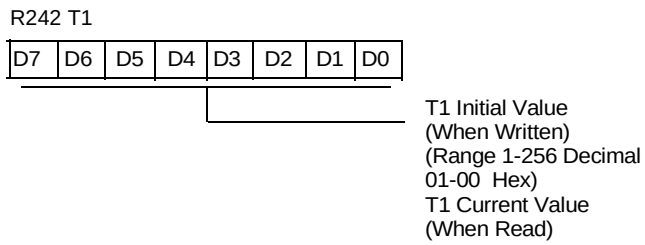


Figure 23. Counter Timer 1 Register (F2h: Read/Write)

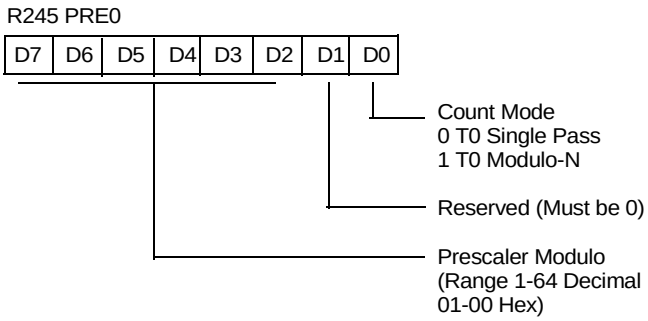


Figure 26. Prescaler 0 Register (F5h: Write Only)

Port 2 Mode Register

The Port 2 Mode Register, P2M, controls Port 2 I/O functions and is shown in Figure 27.

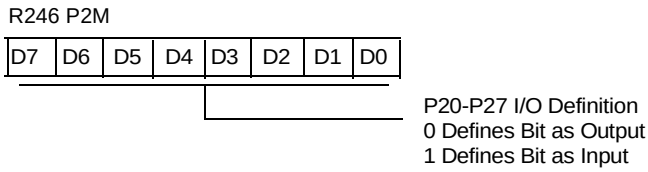


Figure 27. Port 2 Mode Register (F6h: Write Only)

Port 3 Mode Register

The Port 3 Mode Register P3M controls Port 3 I/O functions and is shown in Figure 28.

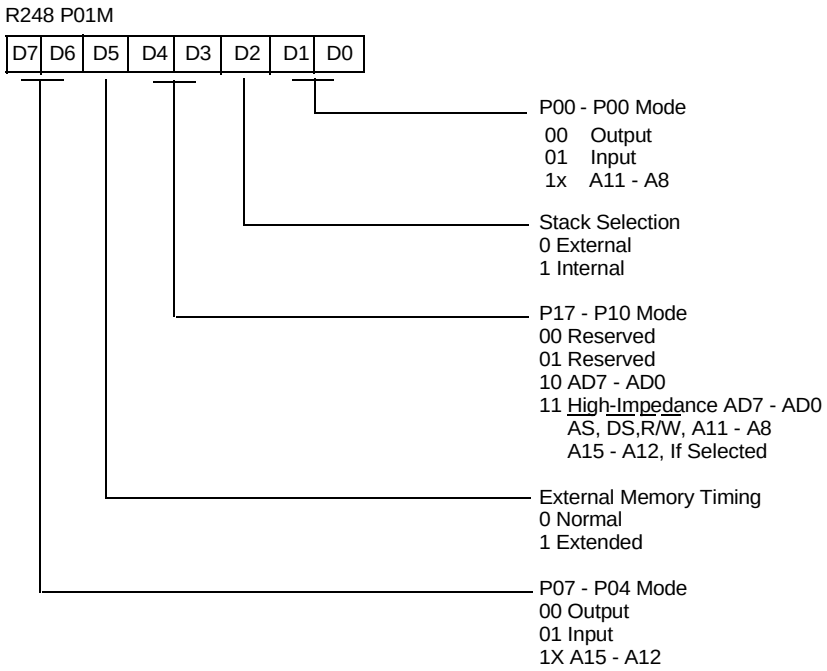


Figure 29. Port 0 and 1 Mode Register (F8h: Write Only)

Interrupt Priority Register. The Interrupt Priority Register, IPR, prioritizes interrupt functions and is shown in Figure 30.

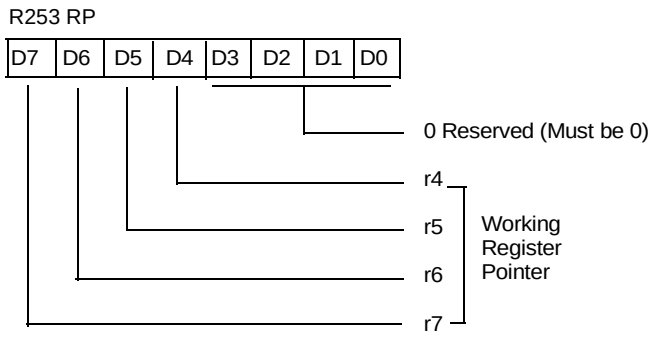


Figure 34. Register Pointer Register (FDh: Read/Write)

Stack Pointer High Register

The Stack Pointer High Register, SPH, controls pointer functions in the upper byte when the external stack is used and is shown in Figure 35.

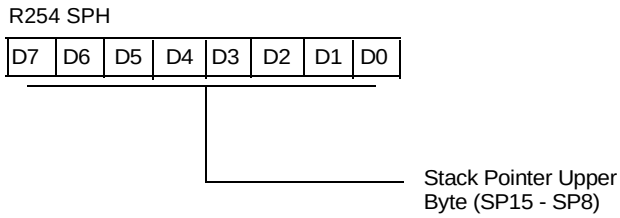


Figure 35. Stack Pointer Register (FEh: Read/Write)

Stack Pointer Low Register

The Stack Pointer Low Register, SPL, controls pointer functions in the lower byte and is shown in Figure 36.

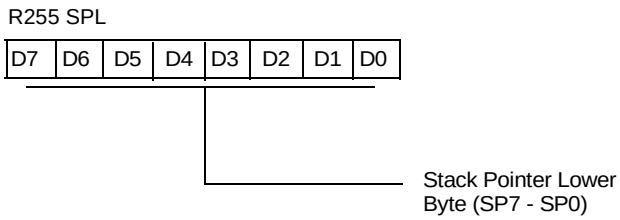


Figure 36. Stack Pointer Register (FFh: Read/Write)

Electrical Characteristics

Absolute Maximum Ratings

Stresses greater than the Absolute Maximum Ratings listed in Table 16 may cause permanent damage to the device. This rating is a stress rating only. Functional operation of the device at any condition above those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for an extended period may affect device reliability.

Table 16. Absolute Maximum Ratings

Symbol	Parameter	Min	Max	Units
V_{CC}	Supply Voltage[1]	–0.3	+7.0	V
T_{STO}	Storage Temperature	–65	+150	C
T_A	Operating Ambient Temperature		[2]	C

Notes:
1. Voltages on all pins with respect to GND.
2. See Ordering Information.

Standard Test Conditions

The characteristics listed below apply for standard test conditions as noted. All voltages are referenced to Ground. Positive current flows into the referenced pin (Figure 37).

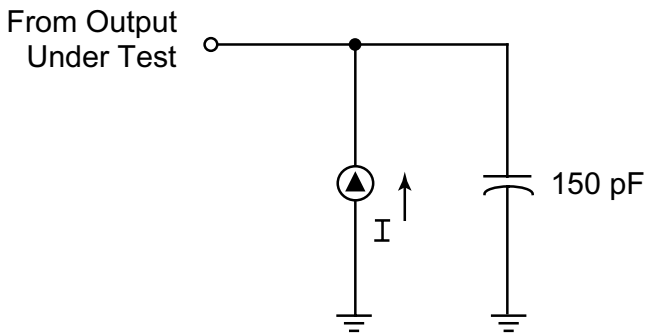


Figure 37. Test Load Diagram

Capacitance

T_A = 25°C, V_{CC} = GND = 0V, f = 1.0 MHz, unmeasured pins returned to GND.

Parameter	Min	Max
Input capacitance	0	12 pF
Output capacitance	0	12 pF
I/O capacitance	0	12 pF

DC Electrical Characteristics

Table 17. DC Electrical Characteristics at Standard and External Temperatures

		T_A = 0°C to +70°C		T_A = -40°C to +105°C		Typical[2]		
Sym	**Parameter**	**Min**	**Max**	**Min**	**Max**	**@25°C**	**Units**	**Conditions**
	Max Input Voltage		7		7		V	I_{IH} <200µA
V_{CH}	Clock Input High Voltage	3.8	V_{CC}	3.8	V_{CC}		V	Driven by External Clock Generator

Note:
1. All inputs driven to 0V, V_{CC} and outputs floating.
2. V_{CC} = 5.0V

Table 17. DC Electrical Characteristics at Standard and External Temperatures (Continued)

		T_A = 0°C to +70°C		T_A = -40°C to +105°C		Typical[2]		
Sym	**Parameter**	**Min**	**Max**	**Min**	**Max**	**@25°C**	**Units**	**Conditions**
V_{CL}	Clock Input Low Voltage	-0.3	0.8	-0.3	0.8		V	Driven by External Clock Generator
V_{IH}	Input High Voltage	2.0	V_{CC}	2.0	V_{CC}		V	
V_{IL}	Input Low Voltage	–0.3	0.8	-0.3	0.8		V	
V_{OH}	Output High Voltage	2.4		2.4			V	I_{OH} = -2.0 mA
V_{OH}	Output High Voltage	V_{CC}–100mV		V_{CC}–100mV			V	I_{OH} = -100 µA
V_{OL}	Output Low Voltage		0.4		0.4		V	I_{OH} = +2 mA
V_{RH}	Reset Input High Voltage	3.8	V_{CC}	3.8	V_{CC}		V	
V_{RL}	Reset Input Low Voltage	–0.3	0.8	-0.3	0.8		V	
I_{IL}	Input Leakage	–2	2	-2	2		µA	Test at 0 V, V_{CC}
I_{OL}	Output Leakage	–2	2	-2	2		µA	Test at 0 V, V_{CC}
I_{IR}	Reset Input Current		–80		-80		µA	V_{RL}=0V
I_{CC}	Supply Current		35		35	24	mA	@ 16 MHz([1])
I_{CC1}	Standby Current		7		7	4.5	mA	HALT Mode V_{IN} = 0 V, V_{CC} @ 16 MHz
I_{CC2}	Standby Current		10		10	1	µA	STOP Mode V_{IN} = 0 V, V_{CC} ([1])
I_{ALL}	Autolatch Low Current	-10	10	-14	14		µA	

Note:
1. All inputs driven to 0V, V_{CC} and outputs floating.
2. V_{CC} = 5.0V

Table 18. External I/O or Memory READ/WRITE Timing—Standard/Extended Temperature

			T_A = –0°C to 70°C @ 16 MHz		T_A = –40°C to 105°C @ 16 MHz			
No	**Symbol**	**Parameter**	**Min**	**Max**	**Min**	**Max**	**Units**	**Notes**
1	T_DA(AS)	Address Valid to $\overline{AS}$ Rise Delay	25		25		ns	2,3
2	T_DAS(A)	$\overline{AS}$ Rise to Address Float Delay	35		35		ns	2,3
3	T_DAS(DR)	$\overline{AS}$ Rise to Read Data Req'd Valid		180		180	ns	1,2,3
4	T_WAS	$\overline{AS}$ Low Width	40		40		ns	2,3
5	T_DAS(DS)	Address Float to $\overline{DS}$ Fall	0		0		ns	
6	T_WDSR	$\overline{DS}$ (Read) Low Width	135		135		ns	1,2,3
7	T_WDSW	$\overline{DS}$ (WRITE) Low Width	80		80		ns	1,2,3
8	T_DDSR(DR)	$\overline{DS}$ Fall to Read Data Req'd Valid		75		75	ns	1,2,3
9	T_HDR(DS)	Read Data to $\overline{DS}$ Rise Hold Time	0		0		ns	2,3
10	T_DDS(A)	$\overline{DS}$ Rise to Address Active Delay	50		50		ns	2,3
11	T_DDS(AS)	$\overline{DS}$ Rise to $\overline{AS}$ Fall Delay	35		35		ns	2,3
12	T_DR/W(AS)	R/$\overline{W}$ Valid to $\overline{AS}$ Rise Delay	25		25		ns	2,3
13	T_DDS(R/W)	$\overline{DS}$ Rise to R/$\overline{W}$ Not Valid	35		35		ns	2,3
14	T_DDW(DSW)	WRITE Data Valid to $\overline{DS}$ Fall (WRITE) Delay	25		25		ns	2,3
15	T_DDS(DW)	$\overline{DS}$ Rise to WRITE Data Not Valid Delay	35		35		ns	2,3
16	T_DA(DR)	Address Valid to Read Data Req'd Valid		230		230	ns	1,2,3
17	T_DAS(DS)	$\overline{AS}$ Rise to $\overline{DS}$ Fall Delay	45		45		ns	2,3
18	T_DDI(DS)	Data Input Setup to $\overline{DS}$ Rise	60		60		ns	1,2,3
19	T_DDM(AS)	$\overline{DM}$ Valid to $\overline{AS}$ Rise Delay	30		30		ns	2,3

Notes:
1. When using extended memory timing add 2 TpC.
2. Timing numbers provided are for minimum T_PC.
3. See Clock Cycle Dependent Characteristics table

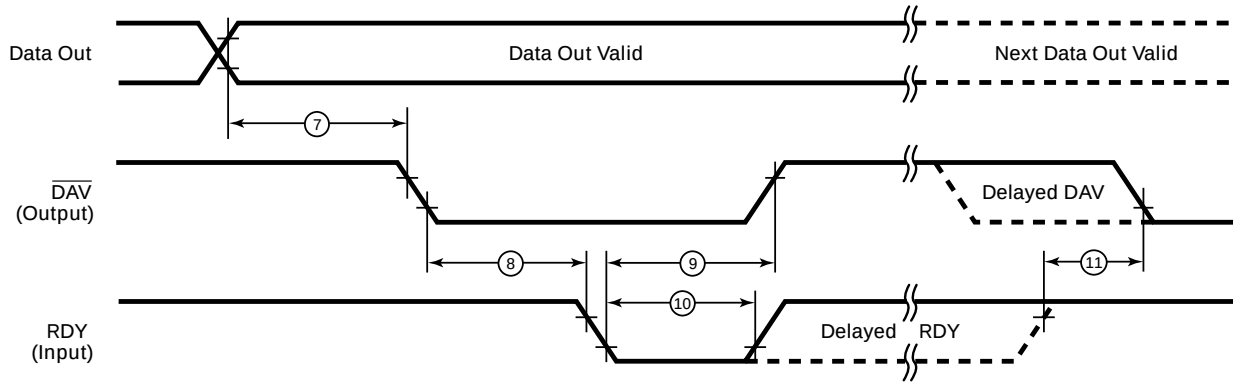


Figure 41. Output Handshake Timing

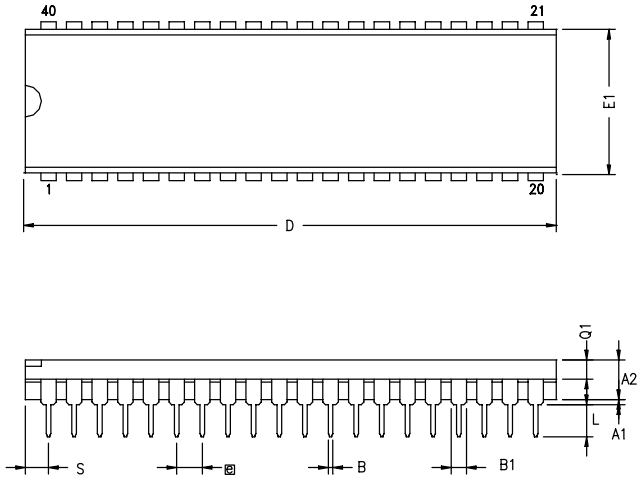
Table 21. Handshake Timing (Standard and Extended Temperatures)

No	Symbol	Parameter	T_A = 0ºC to +70ºC Min	T_A = 0ºC to +70ºC Max	T_A = -40ºC to +105ºC Min	T_A = -40ºC to +105ºC Max	Data Direction
1	T_SDI(DAV)	Data In Setup Time	0		0		Input
2	T_HDI(RDY)	Data In Hold Time	145		145		Input
3	T_WDAV	Data Available Width	110		110		Input
4	T_DDAVI(RDY)	DAV Fall to RDY Fall Delay		115		115	Input
5	T_DDAVId(RDY)	DAV Out to DAV Fall Delay		115		115	Input
6	RDY0$_D$(DAV)	RDY Rise to DAV Fall Delay	0		0		Input
7	T_DD0(DAV)	Data Out to DAV Fall Delay		TpC		TpC	Output
8	T_DDAV0(RDY)	DAV Fall to RDY Fall Delay	0		0		Output
9	T_DRDY0(DAV)	RDY Fall to DAV Rise Delay		115		115	Output
10	T_WRDY	RDY Width	110		110		Output
11	T_DRDY0$_D$(DAV)	RDY Rise to DAV Fall Delay		115		115	Output

Note: All timing references use 2.0V for a logic 1 and 0.8V for a logic 0.

Packaging

Figure 42 illustrates the 40-pin DIP package for the microcontroller devices.



SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A1	0.51	1.02	.020	.040
A2	3.18	3.94	.125	.155
B	0.38	0.53	.015	.021
B1	1.02	1.52	.040	.060
C	0.23	0.38	.009	.015
D	52.07	52.58	2.050	2.070
E	15.24	15.75	.600	.620
E1	13.59	14.22	.535	.560
e	2.54 TYP		.100 TYP	
eA	15.49	16.76	.610	.660
L	3.05	3.81	.120	.150
Q1	1.40	1.91	.055	.075
S	1.52	2.29	.060	.090

CONTROLLING DIMENSIONS : INCH

Figure 42. 40-Pin DIP Package Diagram

Document Information

Document Number Description

The Document Control Number that appears in the footer of each page of this document contains unique identifying attributes, as indicated in the following table:

PS	Product Specification
0185	Unique Document Number
01	Revision Number
0802	Month and Year Published

Customer Feedback Form

Z86C91 Product Specification

If you experience any problems while operating this product, or if you note any inaccuracies while reading this Product Specification, please copy and complete this form, then mail or fax it to ZiLOG (see *Return Information*, below). We also welcome your suggestions!

Customer Information

Name	Country
Company	Phone
Address	Fax
City/State/Zip	E-Mail

Product Information

Serial # or Board Fab #/Rev. #
Software Version
Document Number
Host Computer Description/Type

Return Information

ZiLOG
System Test/Customer Support
532 Race Street
San Jose, CA 95126-3432
Fax: (408) 558-8536
Email: zservice@zilog.com

Problem Description or Suggestion

Provide a complete description of the problem or your suggestion. If you are reporting a specific problem, include all steps leading up to the occurrence of the problem. Attach additional pages as necessary.

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